

C_L Capacitor-Less 500mA Low Power Consumption High Speed LDO Regulator

■ GENERAL DESCRIPTION

The XC6503 series is a 500mA high speed CMOS LDO regulator that can provide stable output voltages even without a load capacitor C_L. The devices are available in fixed output voltage from 1.2V to 5.0V in 0.05V increments

The C_L capacitor-less is possible because phase compensation is carried out internally unlike other LDOs where it is done externally. It results in saving board design space. The current limit fold-back circuit and thermal shutdown circuit work as protection circuit. The XC6503P is a 3-Terminal regulator and the XC6503D has a chip enable function, which enables the entire circuit to be turned off by a low level input signal to the CE pin.

When a C_L capacitor is used, the IC can discharge the electric charge stored at the output capacitor through the internal switch while in standby state, and as a result the V_{OUT} quickly returns to the V_{SS} level.

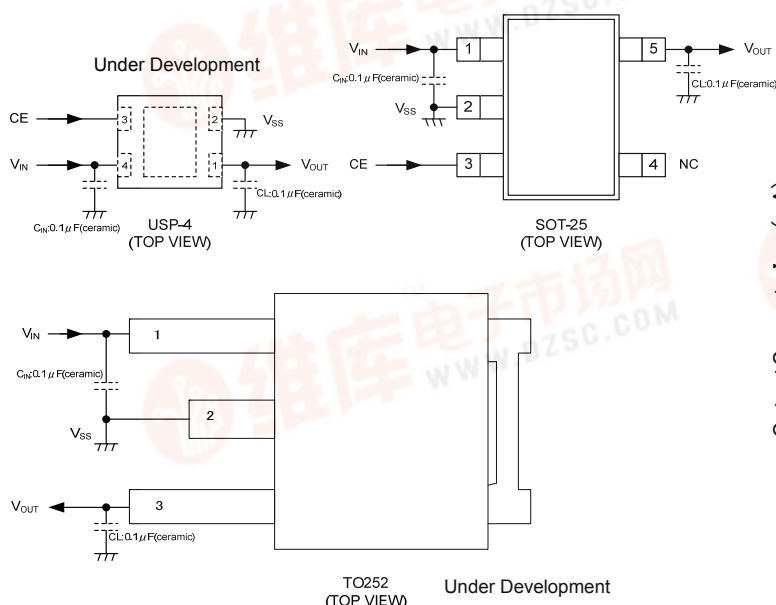
■ APPLICATIONS

- Mobile phones
- Portable game consoles
- Digital still camera modules
- Wireless LAN modules
- Liquid crystal display modules
- Bluetooth modules
- Digital TV tuner modules

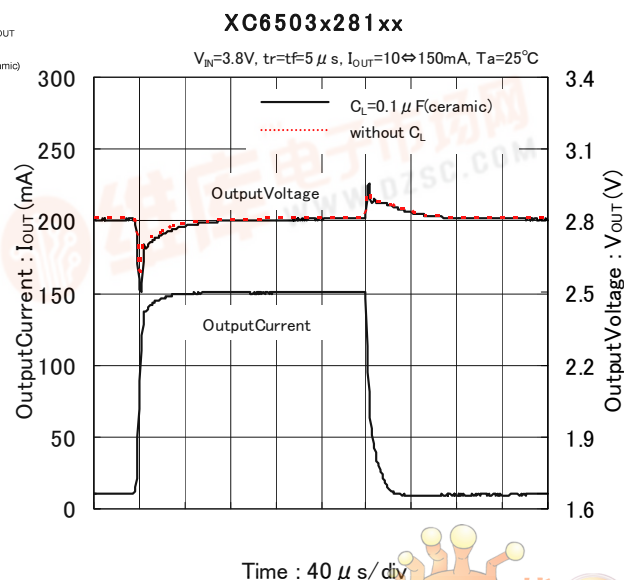
■ FEATURES

Maximum Output Current	: 500mA
Input Voltage Range	: 1.7V ~ 6.0V
Output Voltage Range	: 1.2V ~ 5.0V (0.05V increments)
Output Accuracy	: ±1.0% (2.0V~5.0V) ±20mV (1.2V~1.95V)
Temperature Stability	: ±30ppm/°C
Dropout Voltage	: 190mV@V _{OUT} =2.8V, I _{OUT} =300mA
Low Power Consumption	: 15 μA (TYP.), 0.1 μA (in standby)
High PSRR	: 55dB@1kHz, V _{OUT} =2.8V
Protection Current	: Current Limiter (630mA TYP.) Short-circuit Protection Thermal Shutdown
C _L Capacitor-Less	: Internal Phase Compensation
Operating Temperature Range	: -40°C ~ +85°C
Packages	: USP-4 (*), SOT-25, SOT-89-5 (XC6503D) TO-252 (XC6503P *) *Under Development
Environmentally Friendly	: EU RoHS Compliant, Pb Free

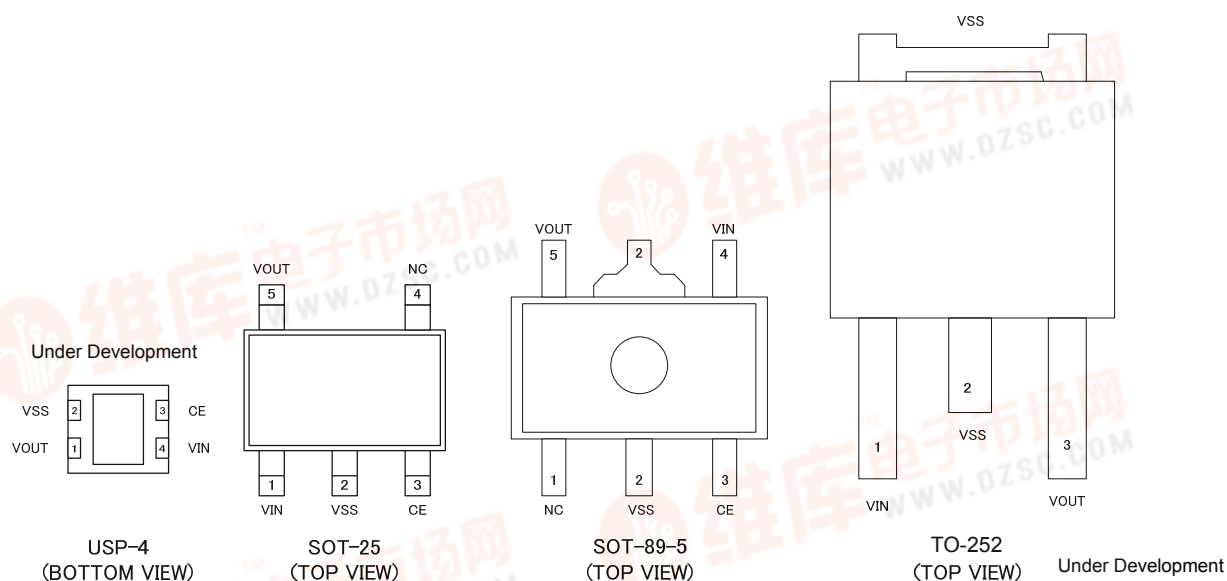
■ TYPICAL APPLICATION CIRCUIT



■ TYPICAL PERFORMANCE CHARACTERISTICS



PIN CONFIGURATION



*The dissipation pad for the USP-4 package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the V_{SS} (No. 2) pin.

PIN ASSIGNMENT

PIN NUMBER				PIN NAME	FUNCTIONS
USP-4	SOT-25	SOT89-5	TO-252		
4	1	4	1	V _{IN}	Power Input
1	5	5	3	V _{OUT}	Output
2	2	2	2	V _{SS}	Ground
3	3	3	-	CE	ON/OFF Control
-	4	1	-	NC	No Connection

* USP-4 and TO-252 are under development.

[查询XC6503供应商](#)

■PRODUCT CLASSIFICATION

●Ordering Information XC6503D with ON/OFF function

XC6503①②③④⑤⑥-⑦^(*)

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	Type of Regulator ^(*)	D	CE Active High, with CE Pull-down, C _L discharge
②③	Output Voltage ^(*)	12~50	ex.) ②=2, ③=8 → 2.8V
④	Output Accuracy	1	±0.02V (1.2~1.9V)、±1% (2.0~5.0V)
⑤⑥-⑦	Packages (Order Unit)	GR-G	USP-4 (3,000/Reel) (Under Development)
		MR-G	SOT-25 (3,000/Reel)
		PR-G	SOT-89-5 (1,000/Reel)

^(*) The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.^(*) For without CE Pull-down or without CL discharge function, please contact your local Torex sales office or representative.^(*) For the output voltage in 0.05V increments, please contact your local Torex sales office or representative.

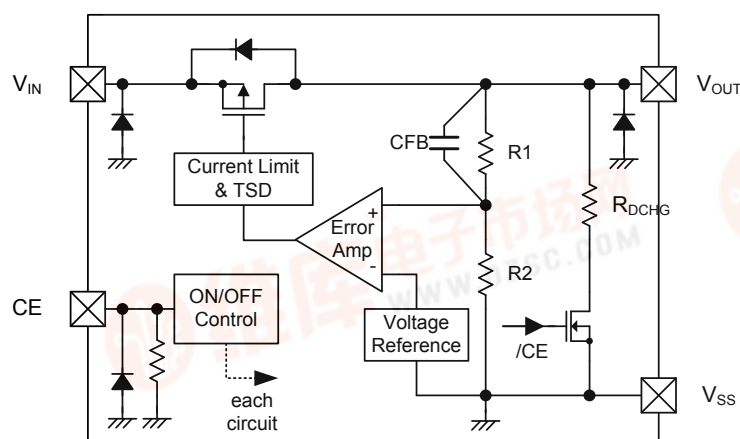
●Ordering Information XC6503P 3-Terminal regulator * Under Development

XC6503①②③④⑤⑥-⑦^(*)

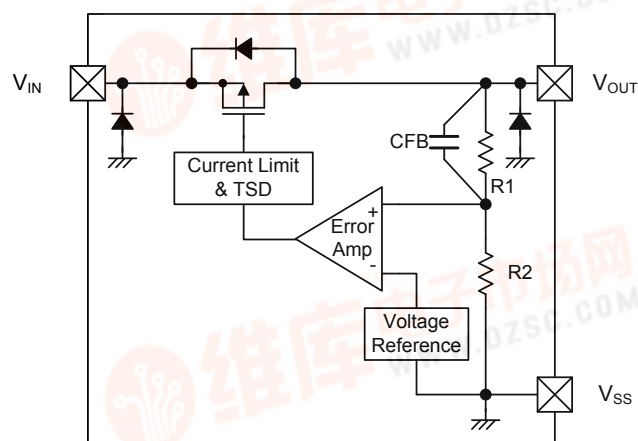
DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	Type of Regulator	P	3-Terminal regulator, without CE pin
②③	Output Voltage ^(*)	12~50	ex.) ②=2, ③=8 → 2.8V
④	Output Accuracy	1	±0.02V (1.2~1.9V)、±1% (2.0~5.0V)
⑤⑥-⑦	Packages (Order Unit)	JR-G	TO-252 (2,500/Reel)

^(*) The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.^(*) For the output voltage in 0.05V increments, please contact your local Torex sales office or representative.

■ BLOCK DIAGRAMS



XC6503D Series



XC6503P Series

Under Development

* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

[查询XC6503供应商](#)

■ABSOLUTE MAXIMUM RATINGS

Ta=25°C

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		V _{IN}	V _{SS} -0.3~+6.5	V
Output Current		I _{OUT}	850 ^(*)	mA
Output Voltage		V _{OUT}	V _{SS} -0.3~V _{IN} +0.3	V
CE Input Voltage		V _{CE}	V _{SS} -0.3~+6.5	V
Power Dissipation	USP-4 ^(*)	Pd	120	mW
	SOT-25		250	
	SOT-89-5		500	
	TO-252 ^(*)		500	
Power Dissipation ^(*) (PCB mounted)	USP-4 ^(*)	Pd	1000	mW
	SOT-25		600	
	SOT-89-5		1300	
	TO-252 ^(*)		1800	
Operating Temperature Range		Topr	-40~+85	°C
Storage Temperature Range		Tstg	-55~+125	°C

(*)1 Pd> (V_{IN}-V_{OUT}) ×I_{OUT}

(*)2 The power dissipation measured with the test board condition is listed as reference data. Please refer to page 22~25 for details.

(*)3 USP-4 and TO-252 are under development.



ELECTRICAL CHARACTERISTICS

●XC6503D Series

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Output Voltage	$V_{OUT(E)}^{(*)2}$	$2.0V > V_{OUT(T)}^{(*)3}, V_{CE}=V_{IN}, I_{OUT}=10mA$	$-0.02^{(*)4}$	$V_{OUT(T)}$	$+0.02^{(*)4}$	V	①
		$2.0V \leq V_{OUT(T)}, V_{CE}=V_{IN}, I_{OUT}=10mA$	$\times 0.99^{(*)4}$		$\times 1.01^{(*)4}$		
Maximum Output Current	I_{OUTMAX}	$V_{CE}=V_{IN}$	500	-	-	mA	①
Load Regulation	ΔV_{OUT}	$V_{CE}=V_{IN}, 0.1mA \leq I_{OUT} \leq 300mA$	-	20	50	mV	①
Dropout Voltage ^{(*)5}	V_{dif}	$V_{CE}=V_{IN}, I_{OUT}=250mA$	E-1			mV	①
Supply Current	I_{DD}	$V_{IN}=V_{CE}=6.0V, I_{OUT}=0mA$	-	15	30	μA	②
Stand-by Current	I_{stby}	$V_{IN}=6.0V, V_{CE}=V_{SS}$	-	0.01	0.1	μA	②
Line Regulation	$\frac{\Delta V_{OUT}}{(\Delta V_{IN} \cdot V_{OUT})}$	$V_{OUT(T)}+0.5V \leq V_{IN} \leq 6.0V, V_{CE}=V_{IN}, I_{OUT}=30mA$	E-2			%/V	①
Input Voltage	V_{IN}		1.7	-	6.0	V	①
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{(\Delta Ta \cdot V_{OUT})}$	$V_{CE}=V_{IN}, I_{OUT}=30mA$ $-40^\circ C \leq Ta \leq 85^\circ C$	-	± 30	-	ppm/°C	①
Ripple Rejection Rate	PSRR	$V_{OUT(T)} \leq 4.75V$ $V_{IN} = [V_{OUT(T)} + 1.0] V_{DC} + 0.5V_{p-pAC}$ $V_{CE}=V_{IN}, I_{OUT}=30mA, f=1kHz$	-	55	-	dB	③
		$V_{OUT(T)} \geq 4.80V$ $V_{IN} = 5.75V_{DC} + 0.5V_{p-pAC}$ $V_{CE}=V_{IN}, I_{OUT}=30mA, f=1kHz$					
Current Limit	I_{LIM}	$V_{CE}=V_{IN}$	510	630	750	mA	①
Short-circuit Current	I_{SHORT}	$V_{CE}=V_{IN}$ Short V_{OUT} to V_{SS} level	-	120	210	mA	①
CE High Level Voltage	V_{CEH}		1.0	-	6.0	V	①
CE Low Level Voltage	V_{CEL}		V_{SS}	-	0.3	V	①
CE High Level Current	I_{CEH}	$V_{IN}=V_{CE}=6.0V$	3.5	6	10	μA	①
CE Low Level Current	I_{CEL}	$V_{CE}=V_{SS}$	-0.1	-	0.1	μA	①
CL Discharge Resistance	R_{DCHG}	$V_{IN}=6.0V, V_{OUT}=5.0V, V_{CE}=V_{SS}$	300	430	500	Ω	①
Thermal Shutdown Detect Temperature	T_{TSD}	Junction Temperature	-	150	-	°C	①
Thermal Shutdown Release Temperature	T_{TSR}	Junction Temperature	-	125	-	°C	①
Thermal Shutdown Hysteresis Width	T_{HYS}	$T_{TSD} - T_{TSR}$	-	25	-	°C	-

NOTE:

(*)1 Unless otherwise stated regarding input voltage conditions, $V_{IN}=V_{OUT(T)}^{(*)3}+1.0V$.(*)2 $V_{OUT(E)}$: Effective output voltage(i.e. the output voltage when " $V_{OUT(T)}+1.0V$ " is provided at the V_{IN} pin while maintaining a certain I_{OUT} value.)(*)3 $V_{OUT(T)}$: Nominal output voltage(*)4 Characteristics of the actual $V_{OUT(E)}$ by setting output voltage is shown in the voltage chart.(*)5 $V_{dif}=V_{IN1}^{(*)7}-V_{OUT1}^{(*)6}$ (*)6 V_{OUT1} is a voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} [$V_{OUT(T)}+1.0V$] is input(*)7 V_{IN1} is an input voltage when V_{OUT1} appears at the V_{OUT} pin while the input voltage is gradually decreased.

[查询XC6503供应商](#)

■ ELECTRICAL CHARACTERISTICS (Continued)

● XC6503P Series

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Output Voltage	$V_{OUT(E)}$ ^(*2)	$2.0V > V_{OUT(T)}^{(*3)}, I_{OUT}=10mA$	-0.02 ^(*4)	$V_{OUT(T)}$	+0.02 ^(*4)	V	①
		$2.0V \leq V_{OUT(T)}, I_{OUT}=10mA$	$\times 0.99$ ^(*4)		$\times 1.01$ ^(*4)		
Maximum Output Current	I_{OUTMAX}		500	-	-	mA	①
Load Regulation	ΔV_{OUT}	$0.1mA \leq I_{OUT} \leq 300mA$	-	20	50	mV	①
Dropout Voltage ^(*5)	V_{dif}	$I_{OUT}=250mA$	E-1			mV	①
Supply Current	I_{DD}	$V_{IN}=6.0V, I_{OUT}=0mA$		15	30	μA	②
Line Regulation	$\frac{\Delta V_{OUT}}{(\Delta V_{IN} \cdot V_{OUT})}$	$V_{OUT(T)}+0.5V \leq V_{IN} \leq 6.0V, I_{OUT}=30mA$	E-2			%/V	①
Input Voltage	V_{IN}		1.7	-	6.0	V	①
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{(\Delta Ta \cdot V_{OUT})}$	$I_{OUT}=30mA$ $-40^{\circ}C \leq Ta \leq 85^{\circ}C$	-	± 30	-	ppm/°C	①
Ripple Rejection Rate	PSRR	$V_{OUT(T)} \leq 4.75V$ $V_{IN} = [V_{OUT(T)} + 1.0] V_{DC} + 0.5V_{p-pAC}$ $I_{OUT}=30mA, f=1kHz$	-	55	-	dB	③
		$V_{OUT(T)} \geq 4.80V$ $V_{IN} = 5.75V_{DC} + 0.5V_{p-pAC}$ $I_{OUT}=30mA, f=1kHz$					
Current Limit	I_{LIM}		510	630	750	mA	①
Short-circuit Current	I_{SHORT}	Short V_{OUT} to V_{SS} level	-	120	210	mA	①
Thermal Shutdown Detect Temperature	T_{TSD}	Junction Temperature	-	150	-	°C	①
Thermal Shutdown Release Temperature	T_{TSR}	Junction Temperature	-	125	-	°C	①
Thermal Shutdown Hysteresis Width	T_{HYS}	$T_{TSD} - T_{TSR}$	-	25	-	°C	-

NOTE:

(*1) Unless otherwise stated regarding input voltage conditions, $V_{IN}=V_{OUT(T)}^{(*3)}+1.0V$.(*2) $V_{OUT(E)}$: Effective output voltage(i.e. the output voltage when " $V_{OUT(T)}+1.0V$ " is provided at the V_{IN} pin while maintaining a certain I_{OUT} value.)(*3) $V_{OUT(T)}$: Nominal output voltage(*4) Characteristics of the actual $V_{OUT(E)}$ by setting output voltage is shown in the voltage chart.(*5) $V_{dif}=V_{IN1}^{(*7)}-V_{OUT1}^{(*6)}$ (*6) V_{OUT1} is a voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} ($V_{OUT(T)}+1.0V$) is input(*7) V_{IN1} is an input voltage when V_{OUT1} appears at the V_{OUT} pin while the input voltage is gradually decreased.

ELECTRICAL CHARACTERISTICS (Continued)

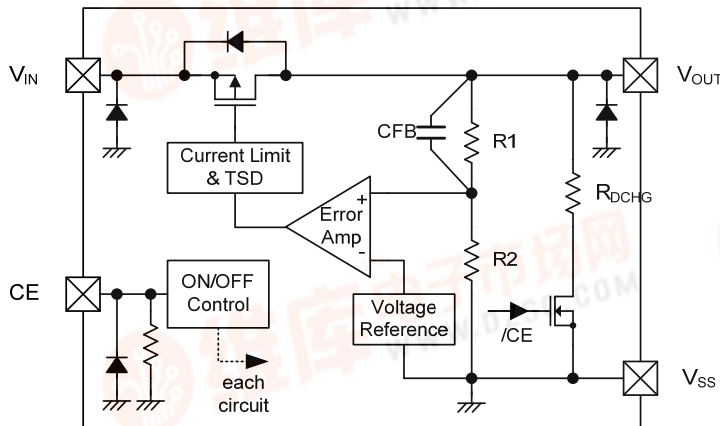
● Voltage Chart

	E-0		E-1		E-2			E-0		E-1		E-2	
NOMINAL VOLTAGE (V)	OUTPUT VOLTAGE (V)		DROPOUT VOLTAGE (mV)		LINE REGULATION (%/V)		NOMINAL VOLTAGE (V)	OUTPUT VOLTAGE (V)		DROPOUT VOLTAGE (mV)		LINE REGULATION (%/V)	
$V_{OUT(T)}$	$V_{OUT(E)}$		V_{dif}		$\frac{\Delta V_{OUT}}{(\Delta V_{IN} \cdot V_{OUT})}$		$V_{OUT(T)}$	$V_{OUT(E)}$		V_{dif}		$\frac{\Delta V_{OUT}}{(\Delta V_{IN} \cdot V_{OUT})}$	
	MIN.	MAX.	TYP.	MAX.	TYP.	MAX.		MIN.	MAX.	TYP.	MAX.	TYP.	MAX.
1.200	1.1800	1.2200	555	660	0.1	0.25	3.150	3.1185	3.1815	190	250	0.1	0.2
1.250	1.2300	1.2700	↑	↑	↑	↑	3.200	3.1680	3.2320	170	230	↑	↑
1.300	1.2800	1.3200	↑	↑	↑	0.2	3.250	3.2175	3.2825	↑	↑	↑	↑
1.350	1.3300	1.3700	↑	↑	↑	↑	3.300	3.2670	3.3330	↑	↑	↑	↑
1.400	1.3800	1.4200	440	560	↑	↑	3.350	3.3165	3.3835	↑	↑	↑	↑
1.450	1.4300	1.4700	↑	↑	↑	↑	3.400	3.3660	3.4340	↑	↑	↑	↑
1.500	1.4800	1.5200	↑	↑	↑	↑	3.450	3.4155	3.4845	↑	↑	↑	↑
1.550	1.5300	1.5700	↑	↑	↑	↑	3.500	3.4650	3.5350	↑	↑	↑	↑
1.600	1.5800	1.6200	360	450	↑	↑	3.550	3.5145	3.5855	↑	↑	↑	↑
1.650	1.6300	1.6700	↑	↑	↑	↑	3.600	3.5640	3.6360	155	210	↑	↑
1.700	1.6800	1.7200	↑	↑	↑	↑	3.650	3.6135	3.6865	↑	↑	↑	↑
1.750	1.7300	1.7700	↑	↑	↑	↑	3.700	3.6630	3.7370	↑	↑	↑	↑
1.800	1.7800	1.8200	300	390	↑	↑	3.750	3.7125	3.7875	↑	↑	↑	↑
1.850	1.8300	1.8700	↑	↑	↑	↑	3.800	3.7620	3.8380	↑	↑	↑	↑
1.900	1.8800	1.9200	↑	↑	↑	↑	3.850	3.8115	3.8885	↑	↑	↑	↑
1.950	1.9300	1.9700	↑	↑	↑	↑	3.900	3.8610	3.9390	↑	↑	↑	↑
2.000	1.9800	2.0200	265	330	↑	↑	3.950	3.9105	3.9895	↑	↑	↑	↑
2.050	2.0295	2.0705	↑	↑	↑	↑	4.000	3.9600	4.0400	↑	↑	↑	↑
2.100	2.0790	2.1210	↑	↑	↑	↑	4.050	4.0095	4.0905	↑	↑	↑	↑
2.150	2.1285	2.1715	↑	↑	↑	↑	4.100	4.0590	4.1410	↑	↑	↑	↑
2.200	2.1780	2.2220	240	310	↑	↑	4.150	4.1085	4.1915	↑	↑	↑	↑
2.250	2.2275	2.2725	↑	↑	↑	↑	4.200	4.1580	4.2420	140	195	↑	↑
2.300	2.2770	2.3230	↑	↑	↑	↑	4.250	4.2075	4.2925	↑	↑	↑	↑
2.350	2.3265	2.3735	↑	↑	↑	↑	4.300	4.2570	4.3430	↑	↑	↑	↑
2.400	2.3760	2.4240	↑	↑	↑	↑	4.350	4.3065	4.3935	↑	↑	↑	↑
2.450	2.4255	2.4745	↑	↑	↑	↑	4.400	4.3560	4.4440	↑	↑	↑	↑
2.500	2.4750	2.5250	210	270	↑	↑	4.450	4.4055	4.4945	↑	↑	↑	↑
2.550	2.5245	2.5755	↑	↑	↑	↑	4.500	4.4550	4.5450	↑	↑	↑	↑
2.600	2.5740	2.6260	↑	↑	↑	↑	4.550	4.5045	4.5955	↑	↑	↑	↑
2.650	2.6235	2.6765	↑	↑	↑	↑	4.600	4.5540	4.6460	↑	↑	↑	↑
2.700	2.6730	2.7270	↑	↑	↑	↑	4.650	4.6035	4.6965	↑	↑	↑	↑
2.750	2.7225	2.7775	↑	↑	↑	↑	4.700	4.6530	4.7470	↑	↑	↑	↑
2.800	2.7720	2.8280	190	250	↑	↑	4.750	4.7025	4.7975	↑	↑	↑	↑
2.850	2.8215	2.8785	↑	↑	↑	↑	4.800	4.7520	4.8480	↑	↑	↑	↑
2.900	2.8710	2.9290	↑	↑	↑	↑	4.850	4.8015	4.8985	↑	↑	↑	↑
2.950	2.9205	2.9795	↑	↑	↑	↑	4.900	4.8510	4.9490	↑	↑	↑	↑
3.000	2.9700	3.0300	↑	↑	↑	↑	4.950	4.9005	4.9995	↑	↑	↑	↑
3.050	3.0195	3.0805	↑	↑	↑	↑	5.000	4.9500	5.0500	↑	↑	↑	↑
3.100	3.0690	3.1310	↑	↑	↑	↑							

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■ OPERATIONAL EXPLANATION

The voltage divided by resistors R1 and R2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET which is connected to the V_{OUT} pin is then driven by the subsequent output signal. The output voltage at the V_{OUT} pin is controlled and stabilized by a system of negative feedback. The current limit circuit and short circuit protection operate in relation to the level of output current and heat dissipation. Current limit circuit and short protection circuit operate with output current and thermal shutdown circuit will operate with heating. Further, the IC's internal circuitry can be shutdown via the CE pin signal.



XC6503D Series

<CL Auto-Discharge Function>

XC6503D can quickly discharge the electric charge at the output capacitor (C_L), when a low signal to the CE pin, which enables a whole IC circuit put into OFF state, is inputted via the N-channel transistor located between the V_{OUT} pin and the V_{SS} pin (cf. BLOCK DIAGRAM). The C_L discharge resistance is set to 430Ω when V_{IN} is 6.0V (TYP.) and V_{OUT} is 5.0V (TYP.). Moreover, discharge time of the output capacitor (C_L) is set by the C_L auto-discharge resistance (R_{DCHG}) and the output capacitor (C_L). By setting time constant of a C_L auto-discharge resistance value (R_{DCHG}) and an output capacitor value (C_L) as τ ($\tau = C \times R$), the output voltage after discharge via the N-channel transistor is calculated by the following formula.

$$V = V_{OUT(E)} \times e^{-t/\tau}, \text{ or } t = \tau \ln(V_{OUT(E)} / V)$$

(V : Output voltage after discharge, V_{OUT(E)} : Initial Output voltage, t: Discharge time,
 τ : C_L auto-discharge resistance R_{DCHG} × C_L Output capacitance)

<Current Limiter, Short-Circuit Protection>

The protection circuit operates as a combination of an output current limiter and fold-back short circuit protection. When load current reaches the current limit level, the output voltage drops. As a result, the load current starts to reduce with showing fold-back curve. The output current finally falls at the level of 120mA when the output pin is short-circuited.

<Thermal Shutdown>

The over heat protection circuit is built-in with the XC6503 series. When the junction temperature of the IC reaches the temperature limit level (150°C TYP.), the thermal shutdown circuit operates and the driver transistor will be turned off. The IC resumes its operation when the thermal shutdown function is released as a result of the junction temperature drops to the release point.

<CE Pin>

The IC's internal circuitry can be shutdown via the signal from the CE pin with the XC6503D series. In shutdown mode, output at the V_{OUT} pin will be pulled down to the V_{SS} level via R1, R2 and C_L auto-discharge resistance R_{DCHG}. Please note the XC6503P does not have the CE pin.

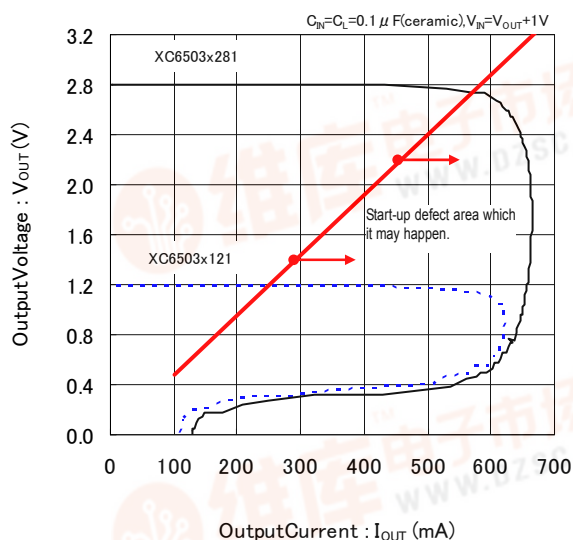
The XC6503D has a pulled down resistor at the CE pin in order to avoid an unstable operation with the CE pin open (the CE pin is left open, operation will be stopped). However, the CE pin input current will increase slightly through the pulled down resistor when operating. If the correct output voltage is applied to the CE pin, the logic is fixed and the IC will operate normally. However, if the medium voltage is input, supply current may increase as a result of an internal through current.

NOTES ON USE

1. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
2. The XC6503 series operates even if without attaching an output capacitor. However, when wiring impedance is high, operations may become unstable due to noise and/or phase lag depending on output current. Please wire the input capacitor (C_{IN}) and the output capacitor (C_L) as close to the IC as possible.
3. The XC6503 installs fold-back current limit circuits. When start-up, this fold-back load curve affects its start-up characteristics. The XC6503 having output current under 2.4V may not happen to start-up with the load conditions below. In these cases, sequence control should be taken for connecting a load after the start-up execution.

Load Condition for Start-up: $I_{OUT} \geq V_{OUT(T)}/4.8$

$V_{OUT(T)}$: Nominal Output Voltage



●CONDITION

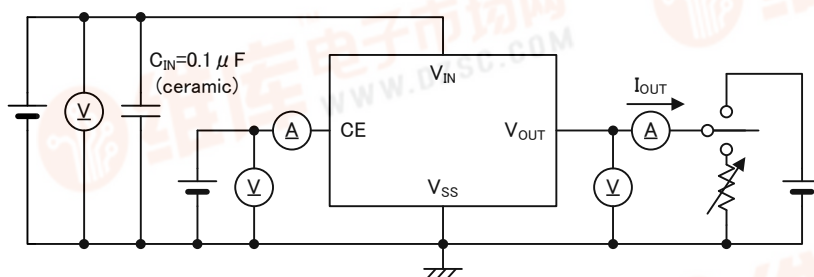
NOMINAL VOLTAGE	LOAD CONDITION FOR START-UP
1.2V	$\leq 250\text{mA}$
1.5V	$\leq 312\text{mA}$
1.8V	$\leq 375\text{mA}$

4. Torex places an importance on improving our products and its reliability. However, by any possibility, we would request user fail-safe design and post-aging treatment on system or equipment.

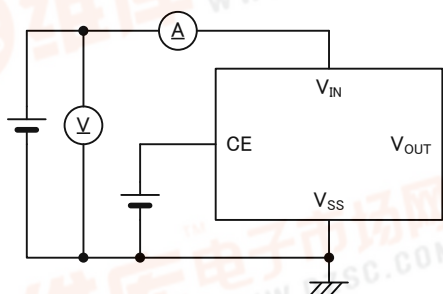
[查询XC6503供应商](#)

■ TEST CIRCUITS

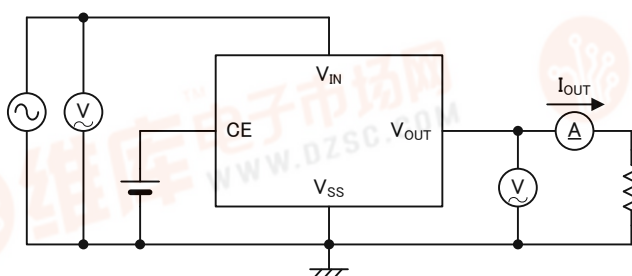
● Circuit ①



● Circuit ②



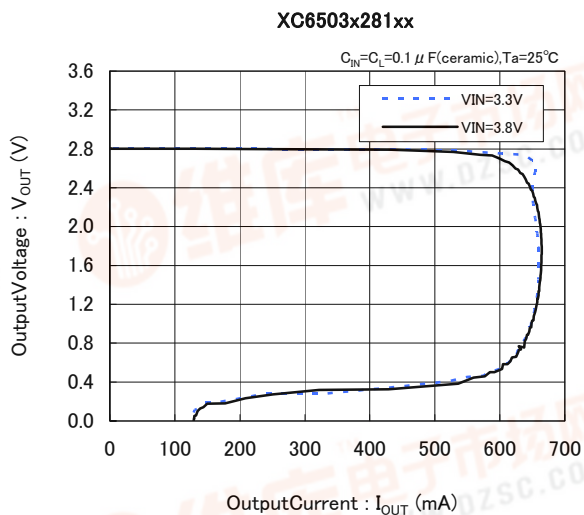
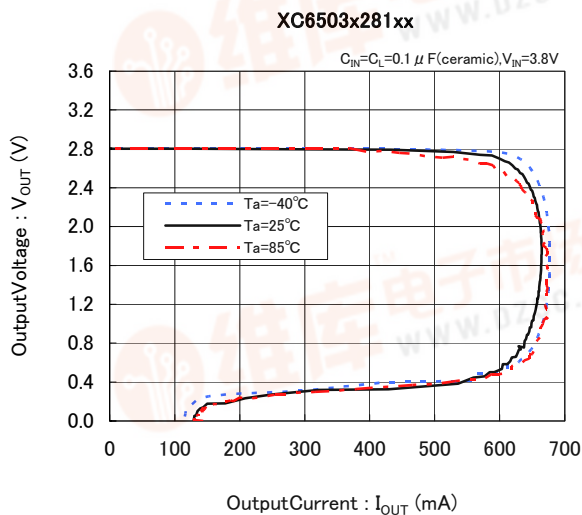
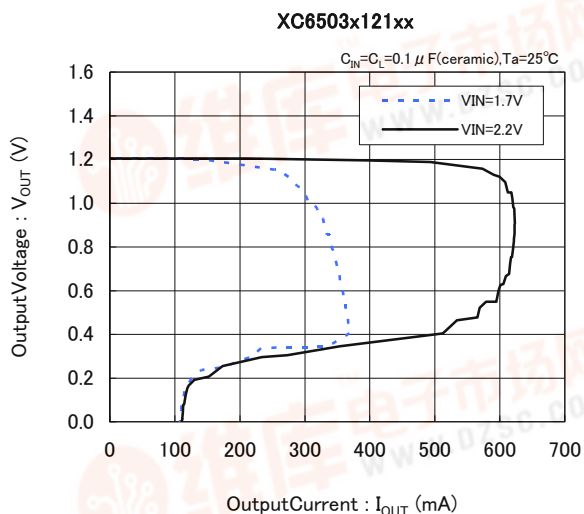
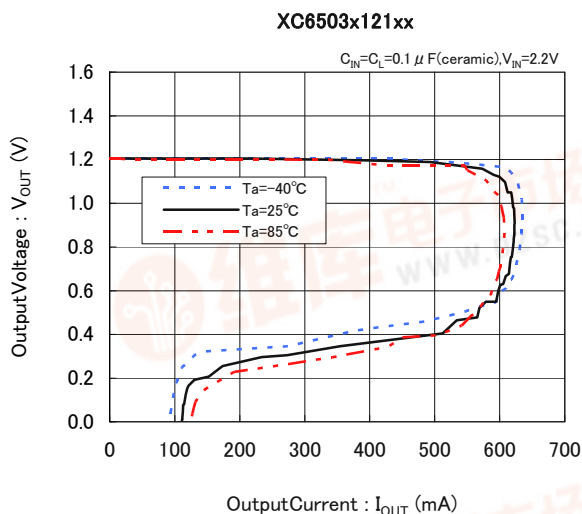
● Circuit ③



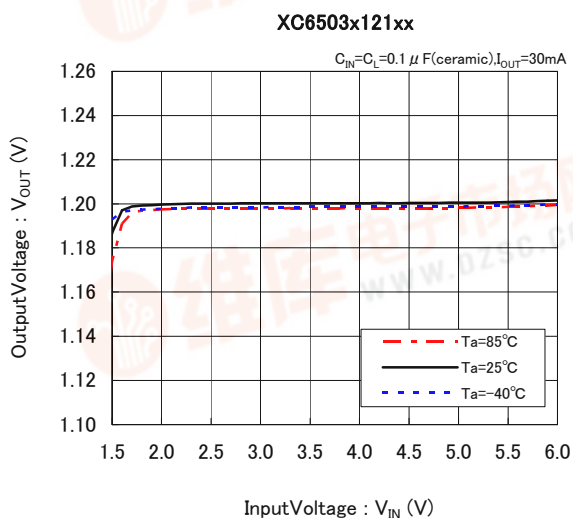
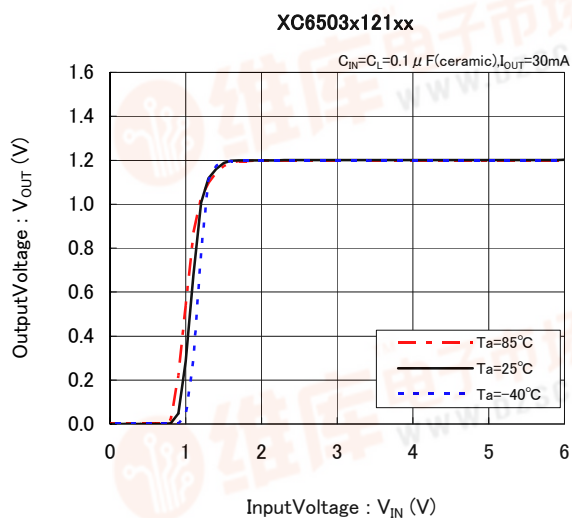
* For the XC6503P series, CE pin is connected to the V_{IN} internally.

TYPICAL PERFORMANCE CHARACTERISTICS

(1) OutputVoltage v.s. OutputCurrent

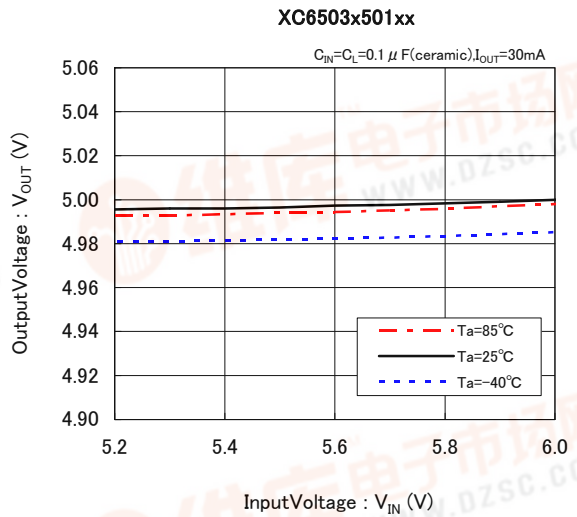
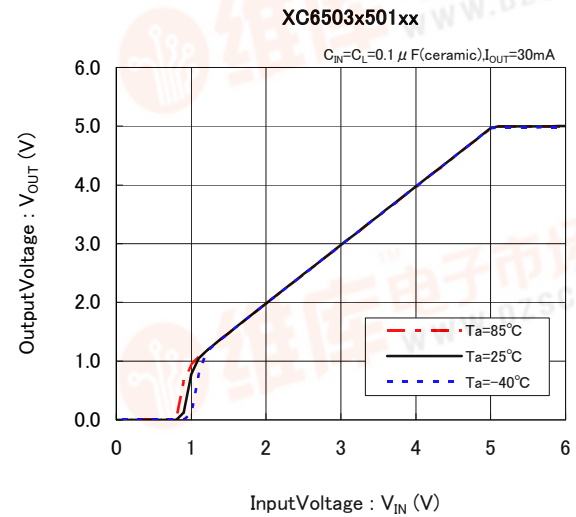
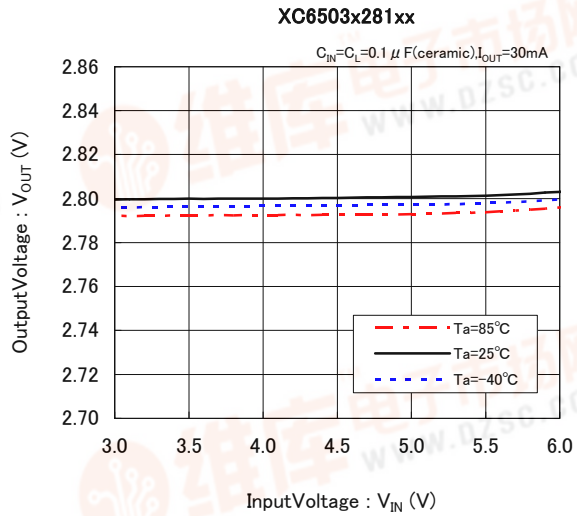
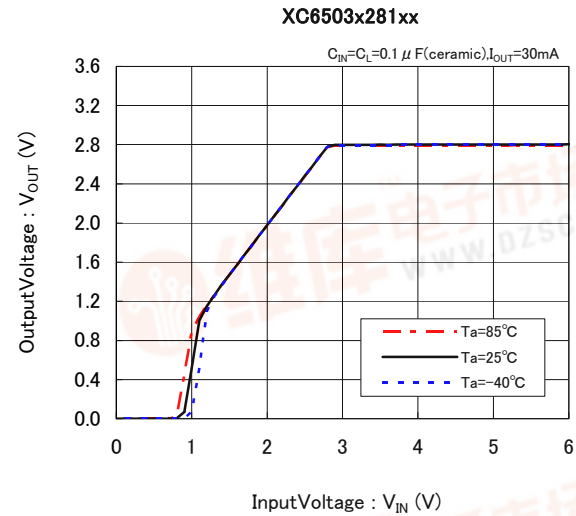


(2) OutputVoltage v.s. InputVoltage

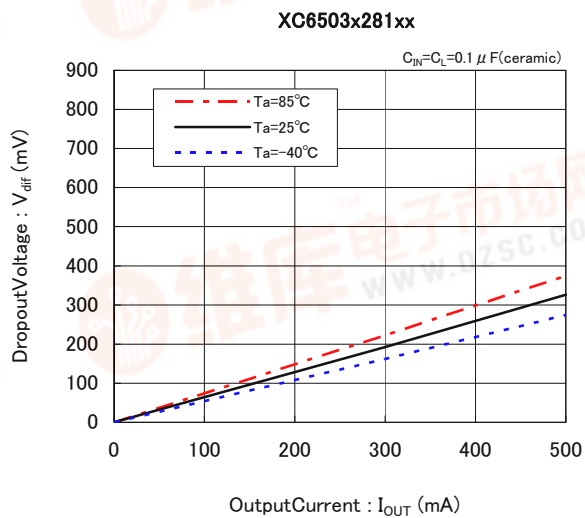
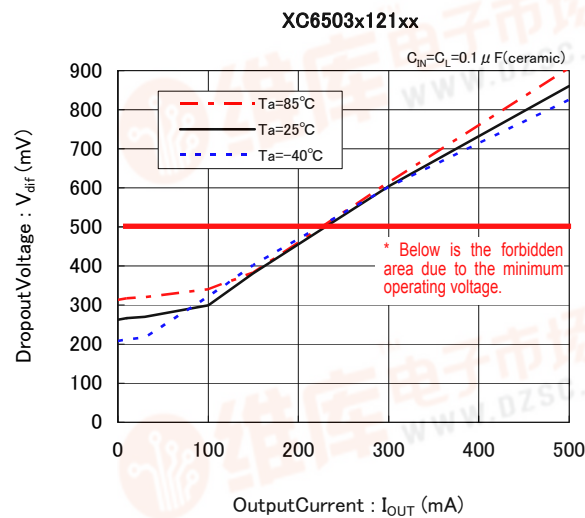


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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) OutputVoltage v.s. InputVoltage

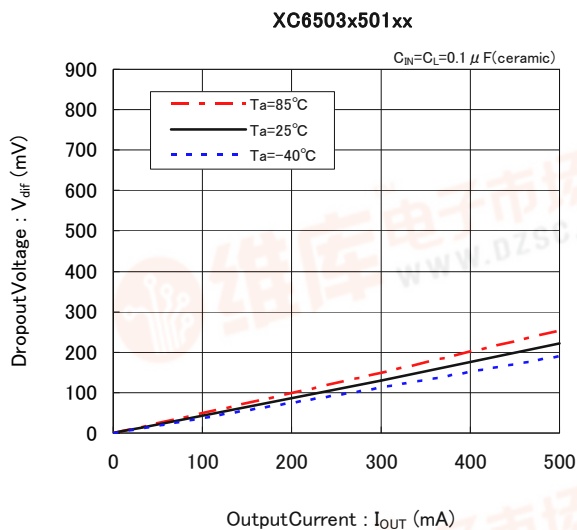


(3) DropoutVoltage v.s. OutputCurrent

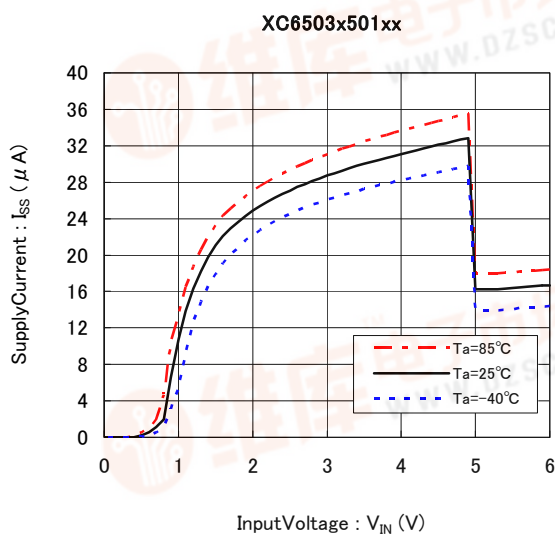
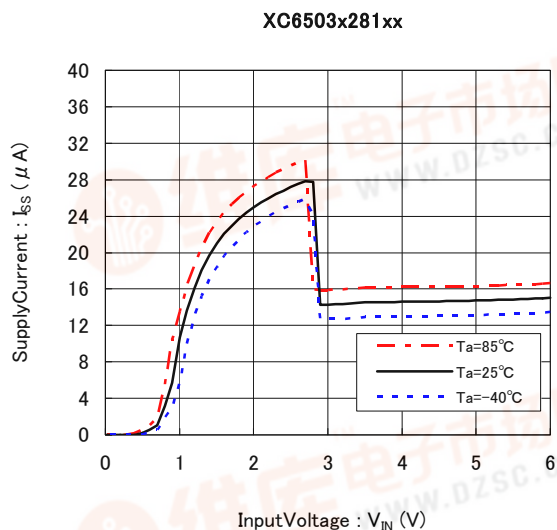
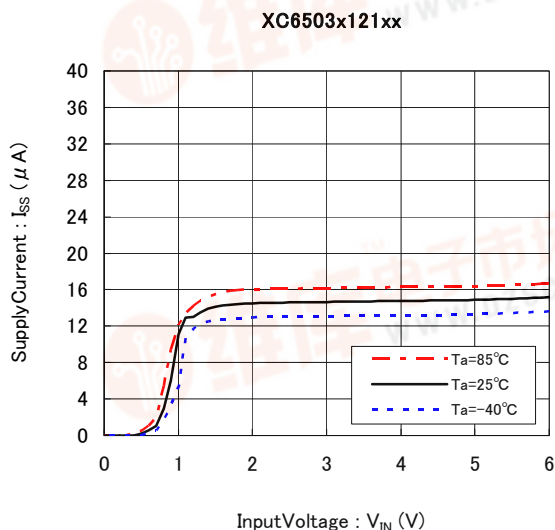


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage v.s. Output Current



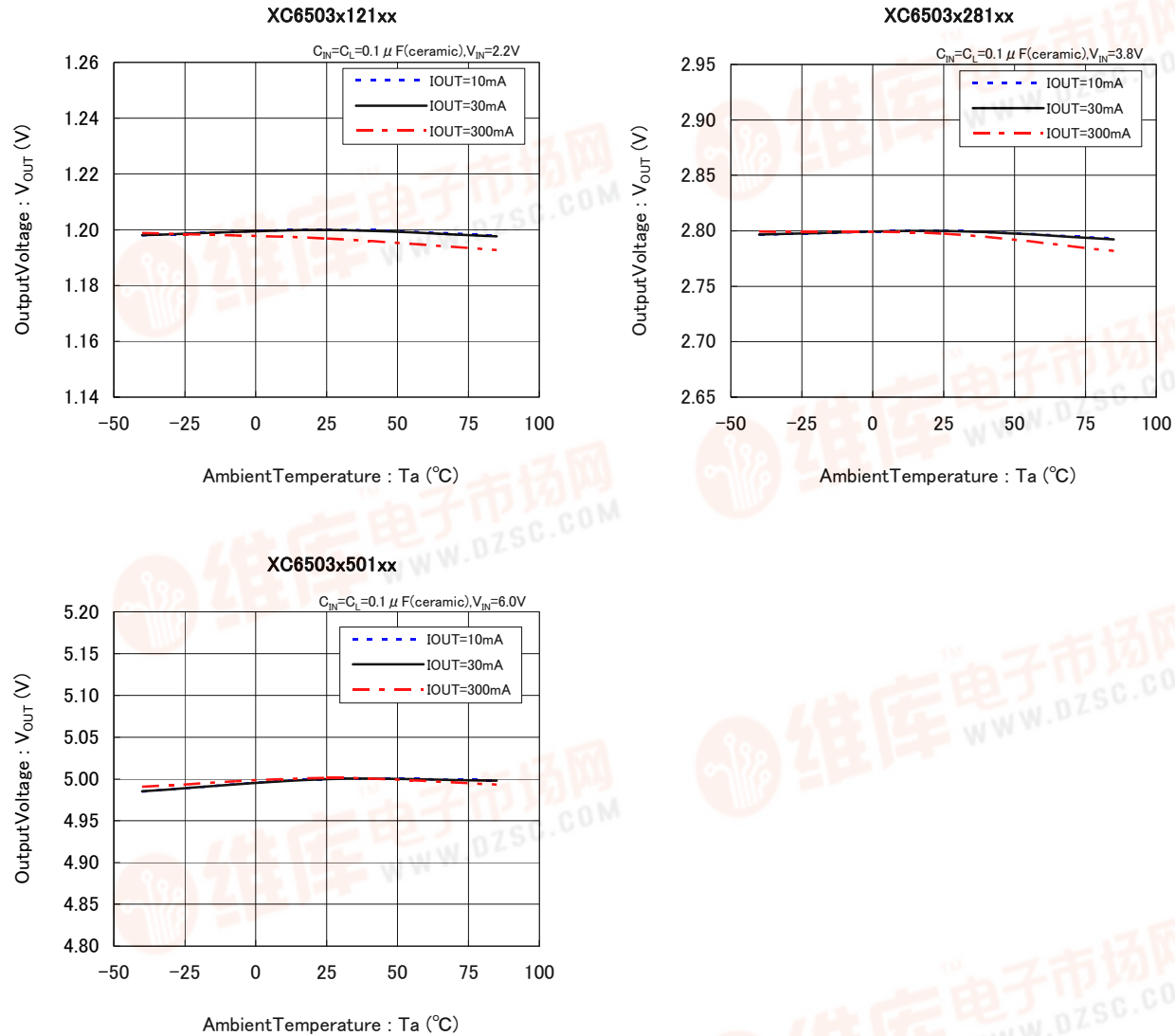
(4) Supply Current v.s. Input Voltage



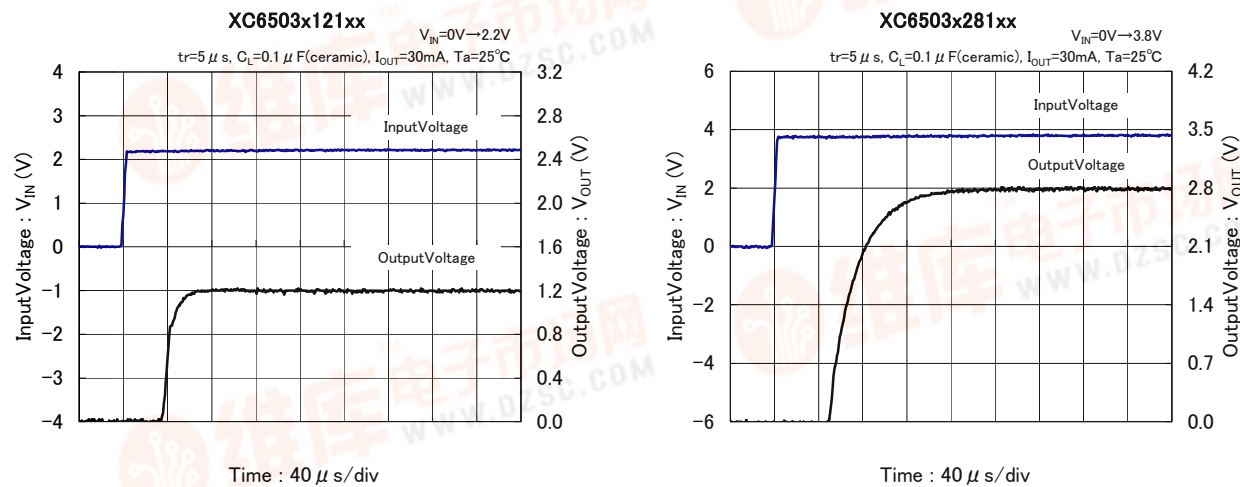
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TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage v.s. Ambient Temperature

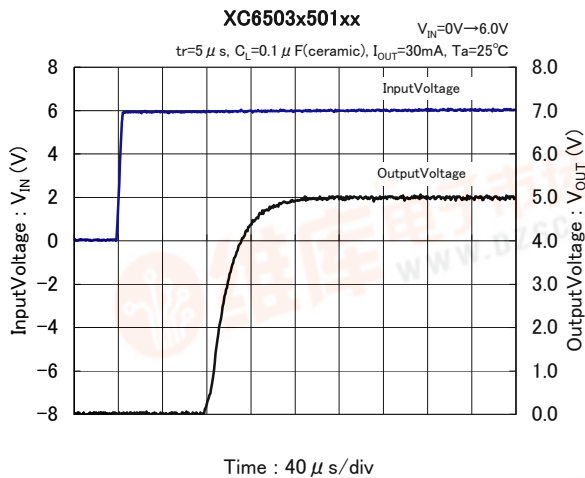


(6) Rising Response Time

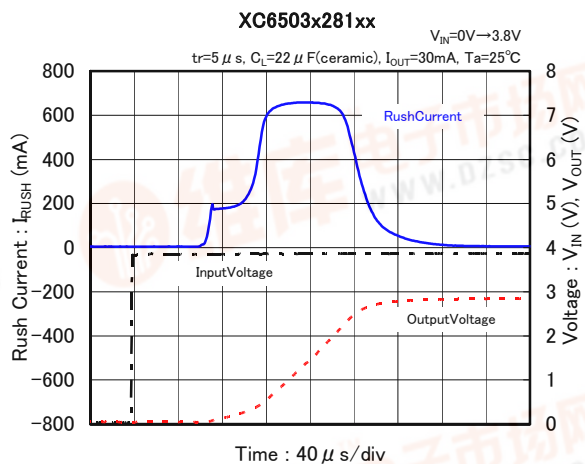
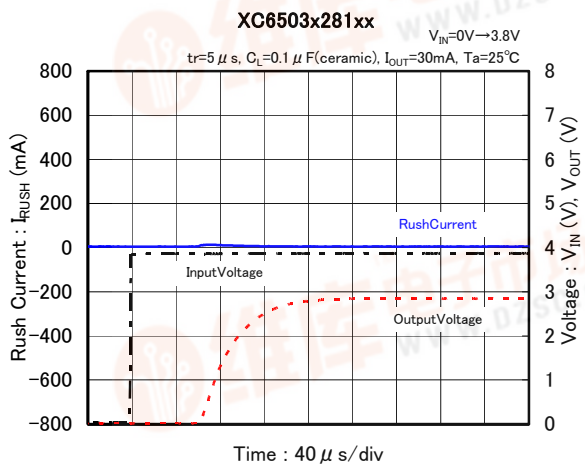


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

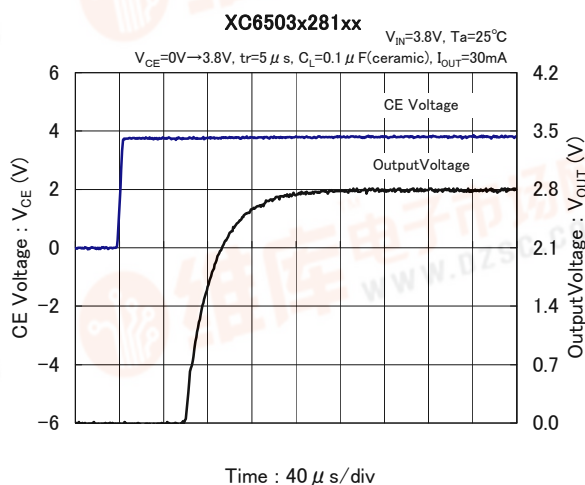
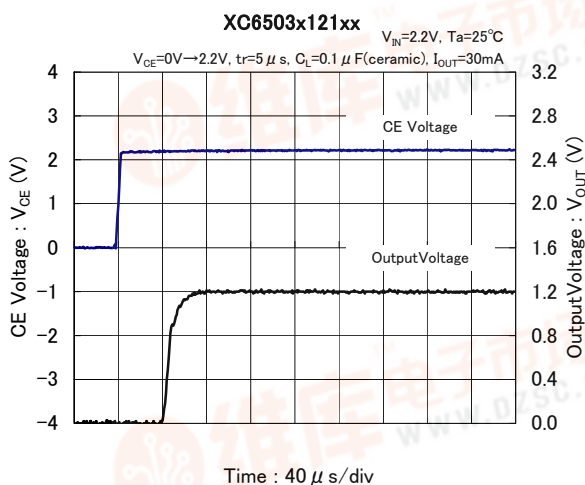
(6) Rising Response Time



(7) Rush Current



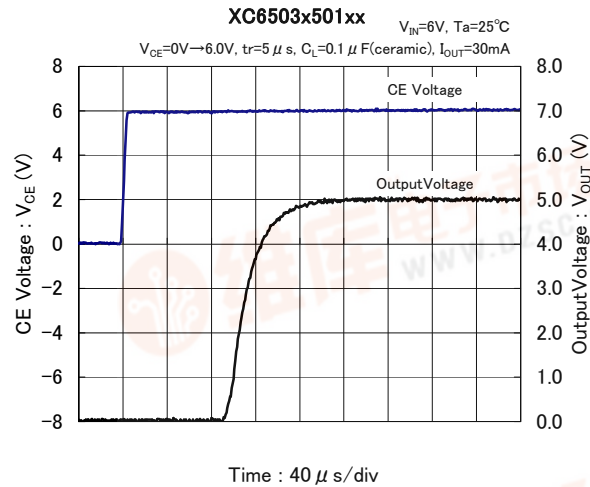
(8) CE Rising Response Time



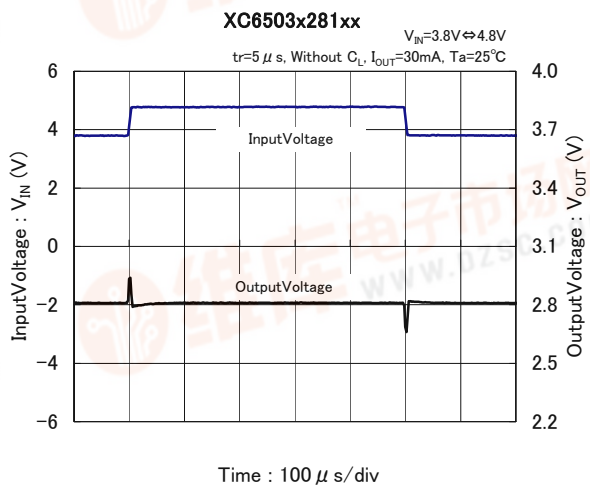
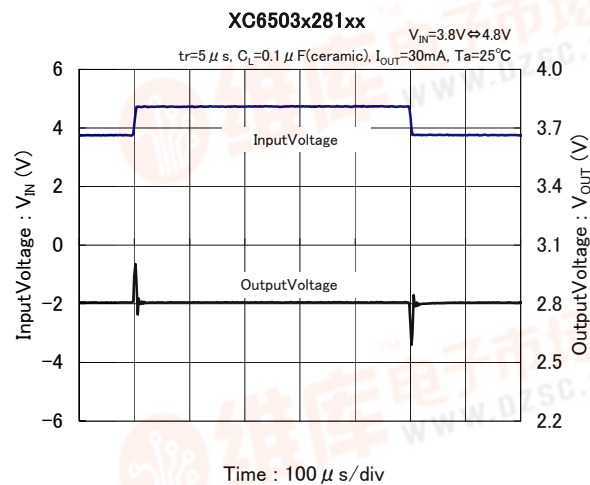
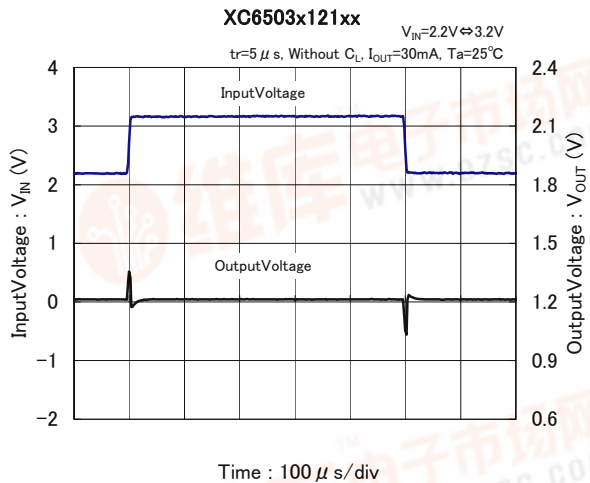
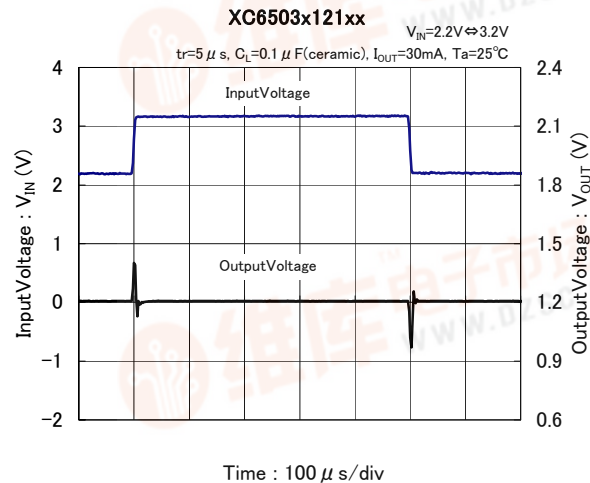
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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) CE Rising Respose Time

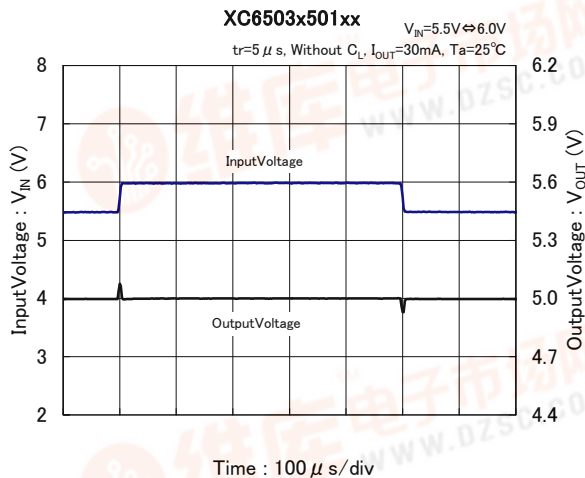
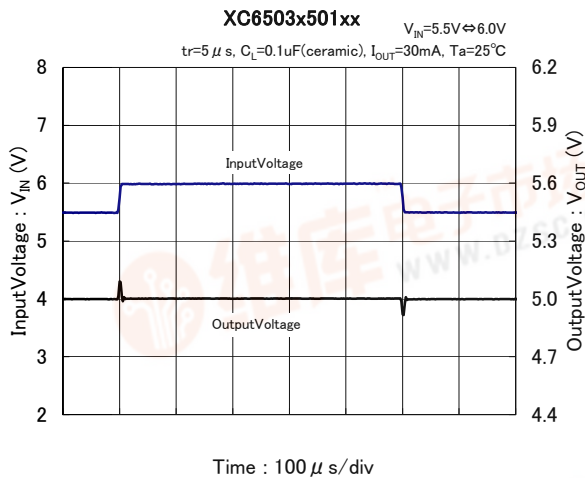


(9) Line transient response

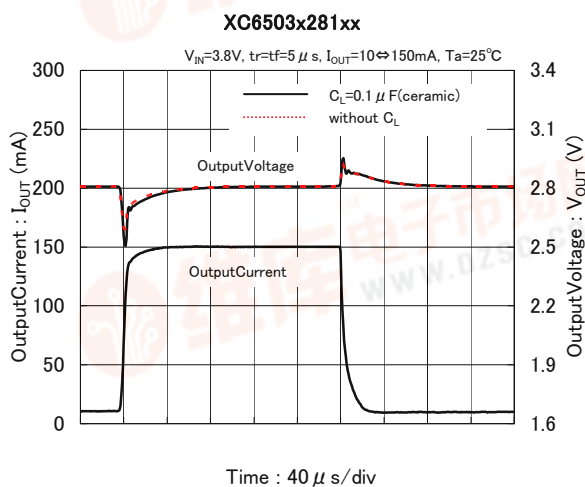
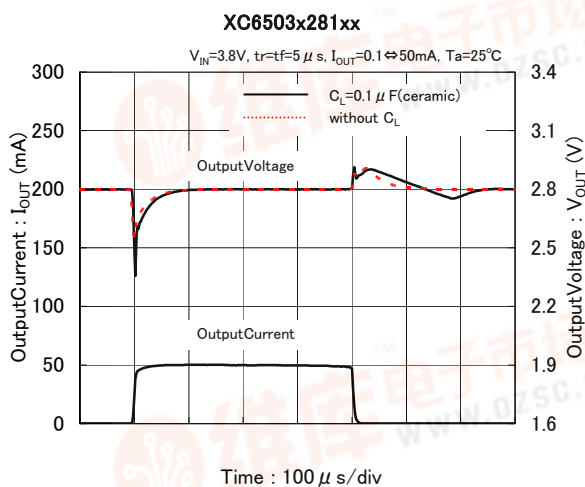
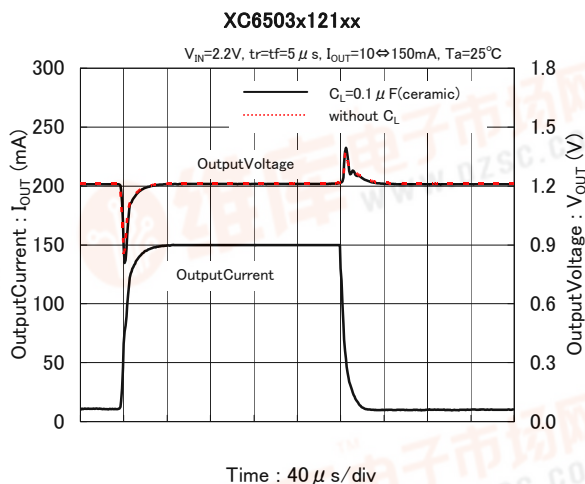
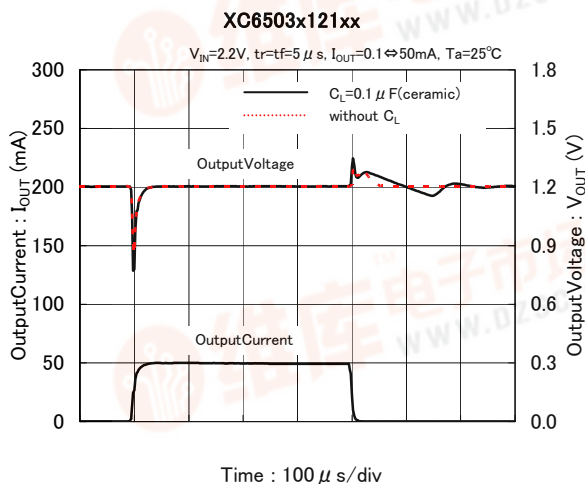


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Line transient response



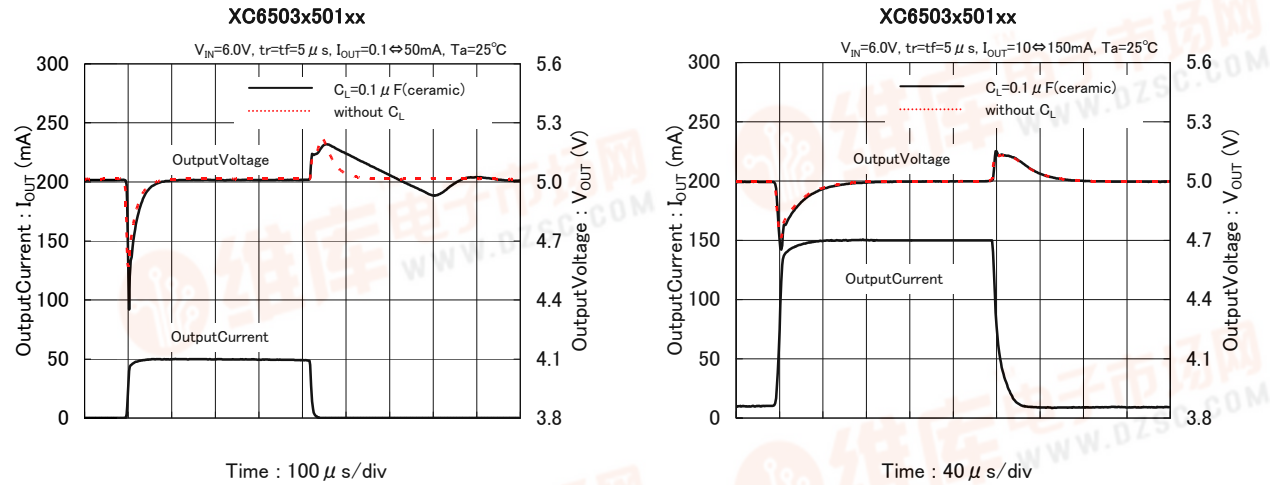
(10) Load transient response



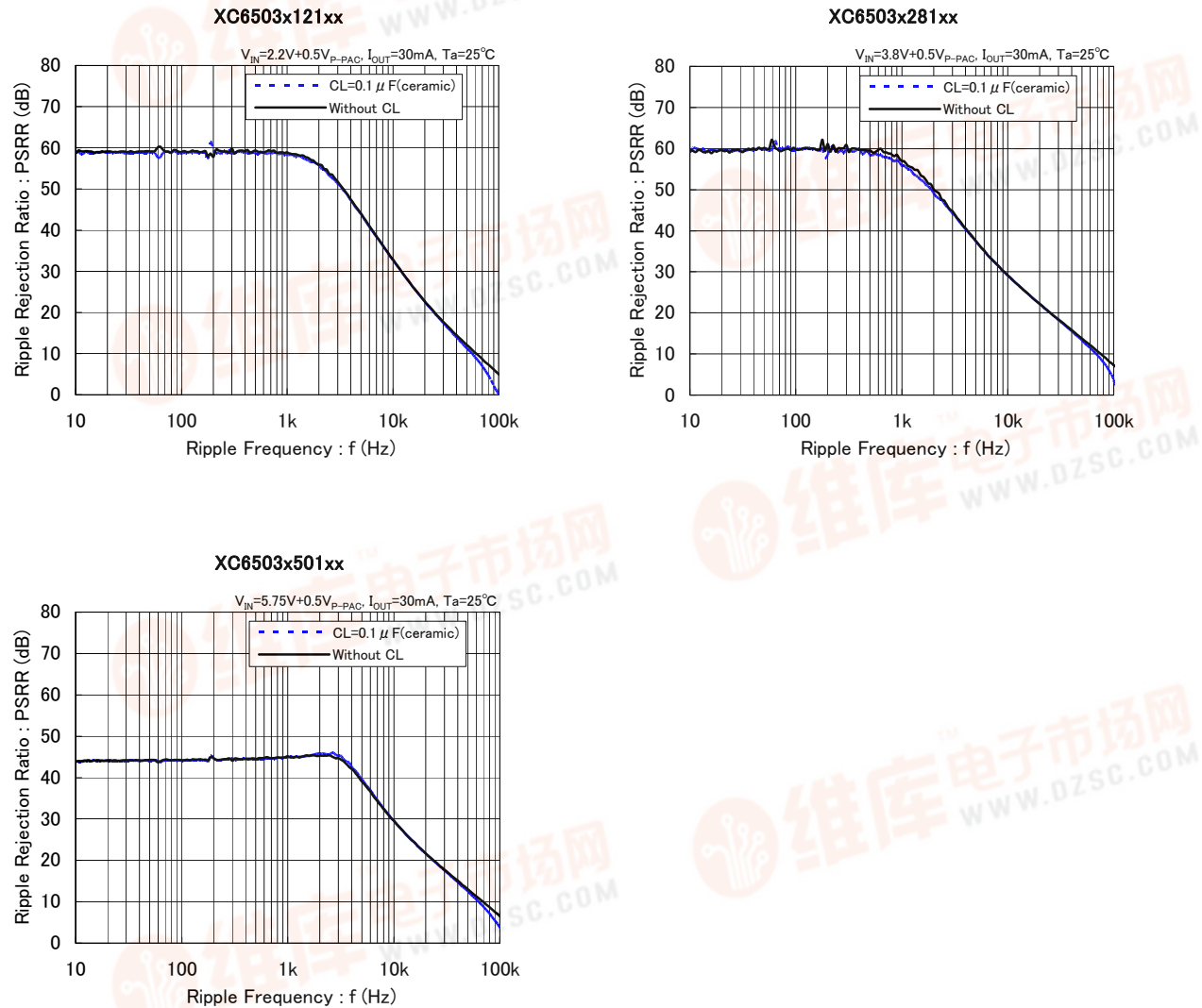
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TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(10) Load transient response

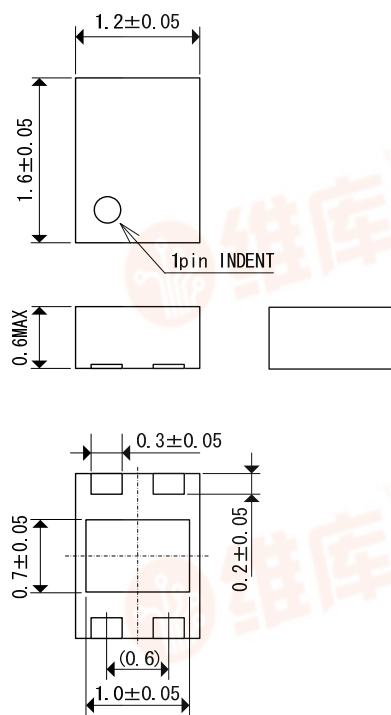


(11) Ripple Rejection Ratio

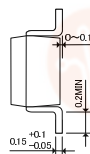
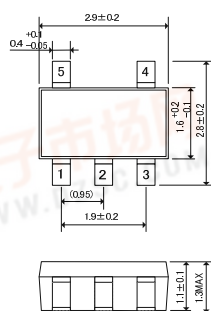


■ PACKAGING INFORMATION

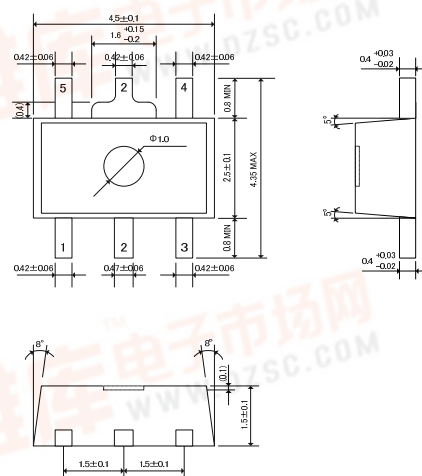
● USP-4



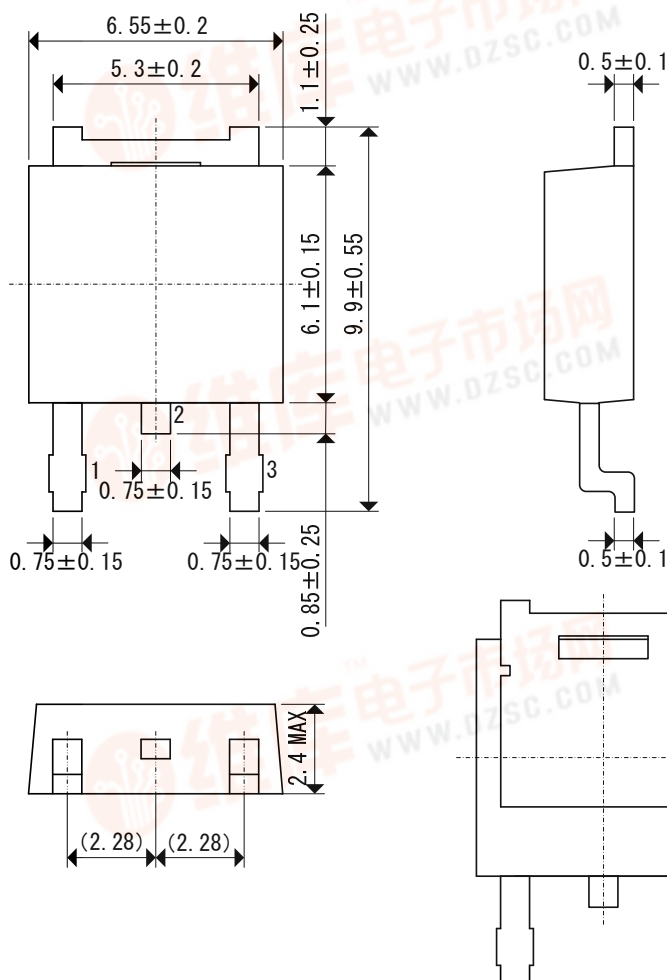
●SOT-25



● SOT-89-5



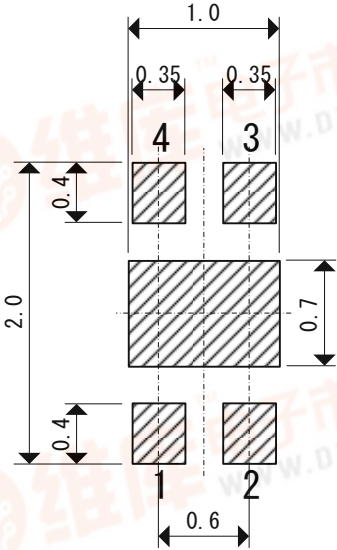
● TO-252



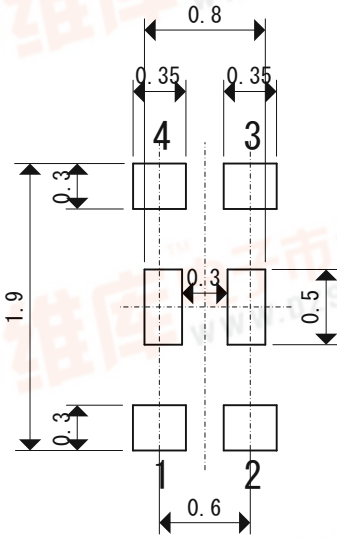
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■ PACKAGING INFORMATION (Continued)

● USP-4 Reference Pattern Layout



● USP-4 Reference Metal Mask Design



PACKAGING INFORMATION (Continued)

● USP-4 Power Dissipation

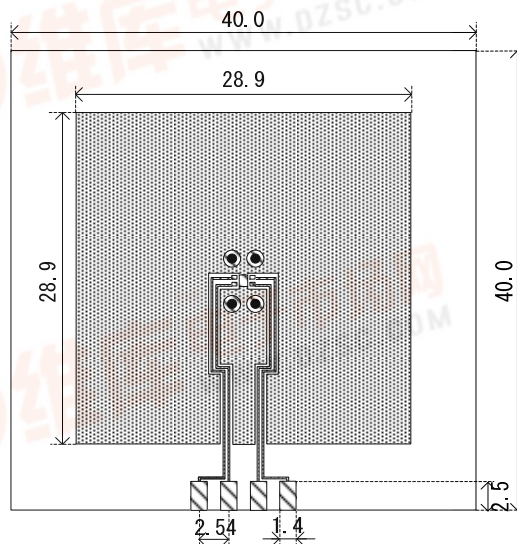
Power dissipation data for the USP-4 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition:	Mount on a board
Ambient:	Natural convection
Soldering:	Lead (Pb) free
Board:	Dimensions 40 x 40 mm (1600 mm ² in one side) Copper (Cu) traces occupy 50% of the board area In top and back faces Package heat-sink is tied to the copper traces
Material:	Glass Epoxy (FR-4)
Thickness:	1.6 mm
Through-hole:	4 x 0.8 Diameter

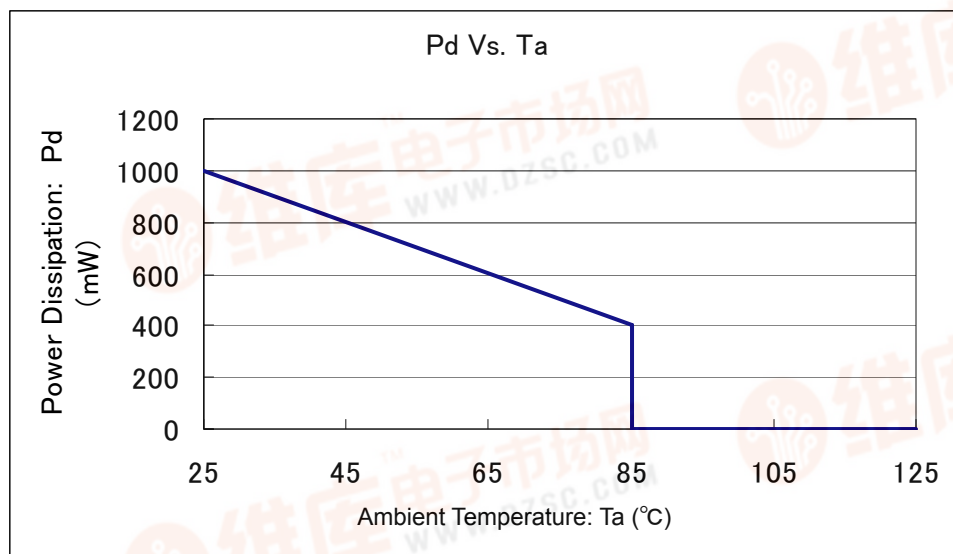


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Board Mount ($T_j \text{ max} = 125^\circ\text{C}$)

Ambient Temperature ($^\circ\text{C}$)	Power Dissipation P_d (mW)	Thermal Resistance ($^\circ\text{C/W}$)
25	1000	100.00
85	400	



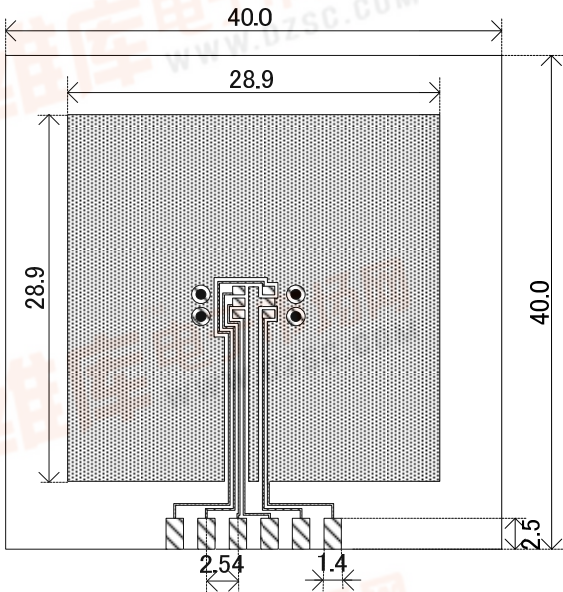
[查询XC6503供应商](#)
■ PACKAGING INFORMATION (Continued)

● SOT-25 Power Dissipation

Power dissipation data for the SOT-25 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

- Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm (1600 mm² in one side)
Copper (Cu) traces occupy 50% of the board area
In top and back faces
Package heat-sink is tied to the copper traces
(Board of SOT-26 is used.)
Material: Glass Epoxy (FR-4)
Thickness: 1.6 mm
Through-hole: 4 x 0.8 Diameter

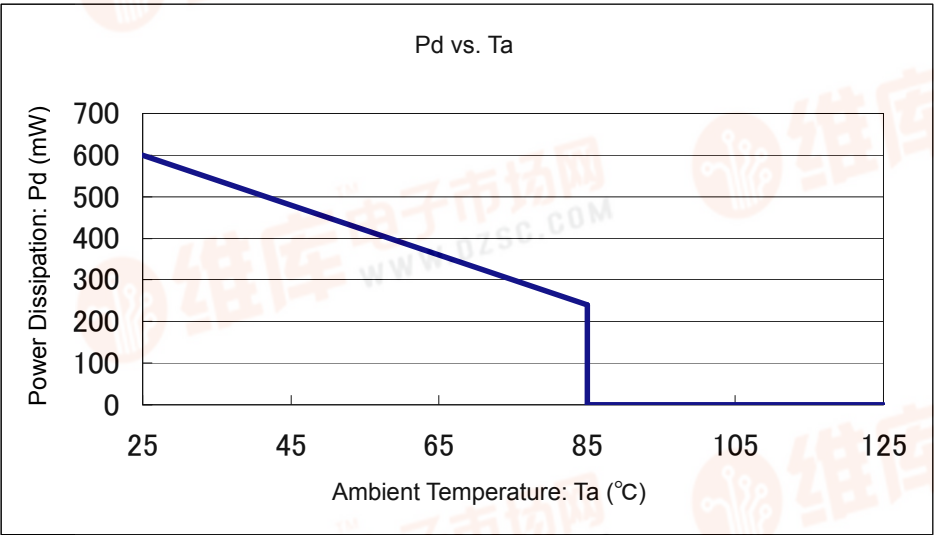


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation Pd (mW)	Thermal Resistance (°C/W)
25	600	166.67
85	240	



PACKAGING INFORMATION (Continued)

● SOT-89-5 Power Dissipation

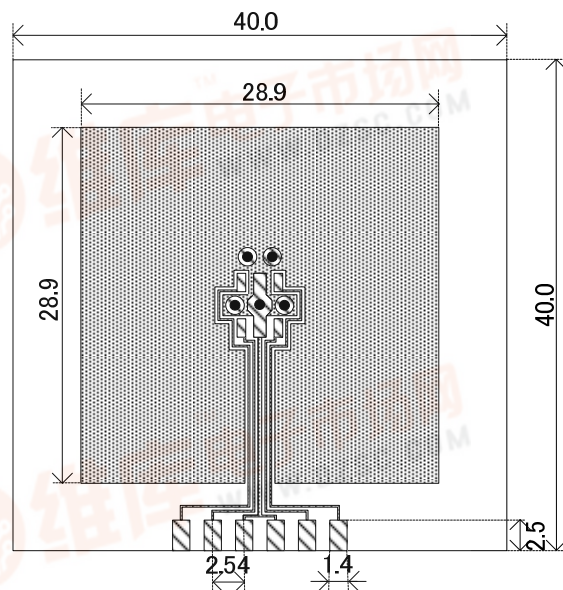
Power dissipation data for the SOT-89-5 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition:	Mount on a board
Ambient:	Natural convection
Soldering:	Lead (Pb) free
Board:	Dimensions 40 x 40 mm (1600 mm ² in one side) Copper (Cu) traces occupy 50% of the board area In top and back faces Package heat-sink is tied to the copper traces
Material:	Glass Epoxy (FR-4)
Thickness:	1.6 mm
Through-hole:	5 x 0.8 Diameter

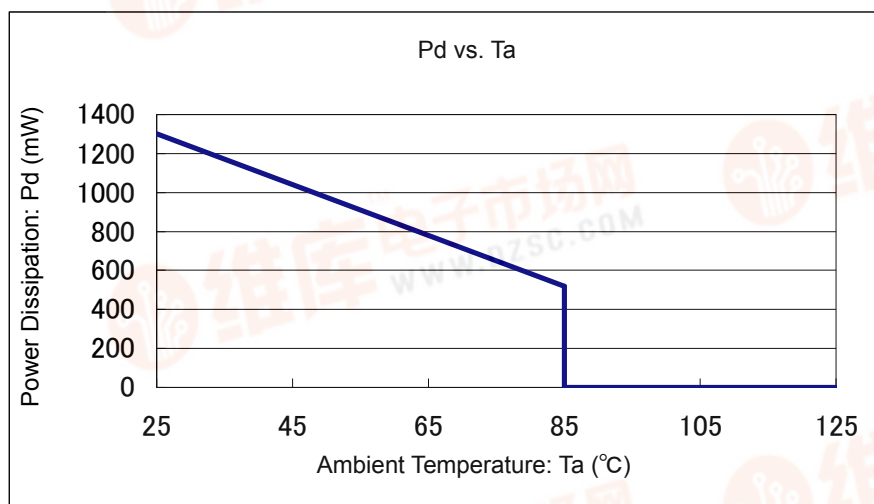


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Board Mount ($T_j \text{ max} = 125^\circ\text{C}$)

Ambient Temperature ($^\circ\text{C}$)	Power Dissipation P_d (mW)	Thermal Resistance ($^\circ\text{C}/\text{W}$)
25	1300	76.92
85	520	



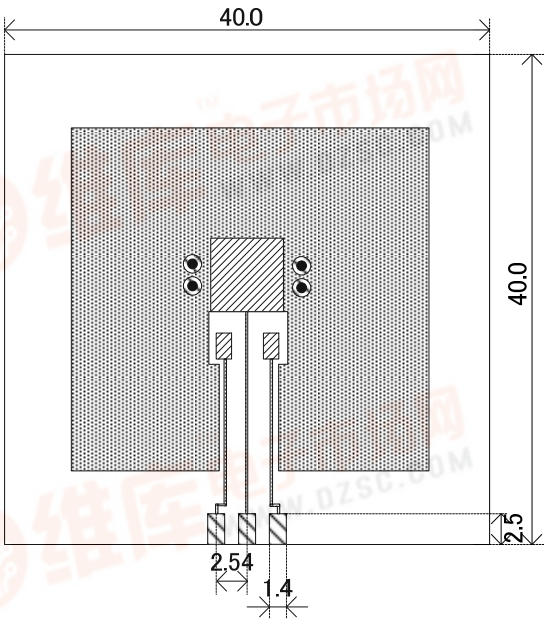
查询XC6503供应商
PACKAGING INFORMATION (Continued)

TO-252 Power Dissipation

Power dissipation data for the TO-252 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

- Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm (1600 mm² in one side)
Copper (Cu) traces occupy 50% of the board area
In top and back faces
Package heat-sink is tied to the copper traces
Material: Glass Epoxy (FR-4)
Thickness: 1.6 mm
Through-hole: 4 x 0.8 Diameter

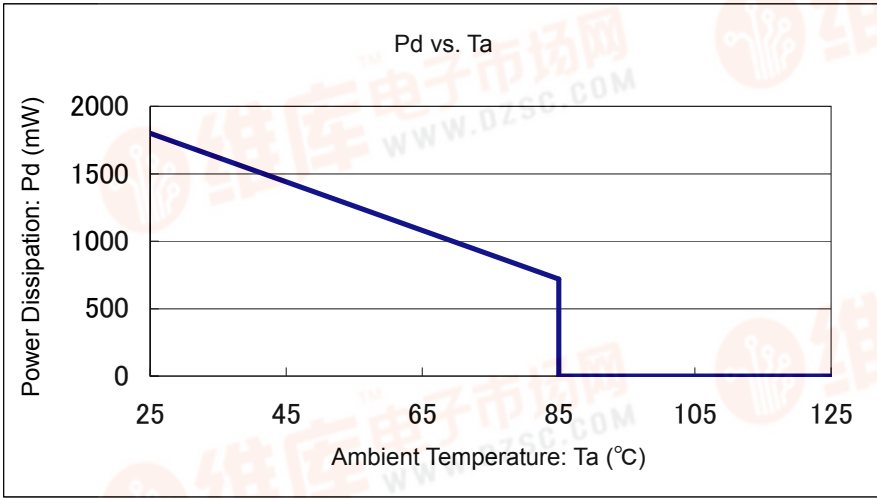


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation Pd (mW)	Thermal Resistance (°C/W)
25	1800	55.56
85	720	



XC6503 Series

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MARKING RULE

● SOT-25, SOT-89-5, USP-4, TO-252

① represents product series.

MARK	PRODUCT SERIES
1 (*)	XC6503*****

(*) Dot mark is printed under MARK ① (refer to drawings below).

② represents type of regulators for standard product.

MARK				PRODUCT SERIES	PACKAGE
OUTPUT VOLTAGE 0.1V INCREMENTS		OUTPUT VOLTAGE 0.05V INCREMENTS			
VOLTAGE= 1.2~4.1V	VOLTAGE= 4.2~5.0V	VOLTAGE= 1.25~4.15V	VOLTAGE= 4.25~4.95V		
0	1	2	3	XC6503A****-G	SOT-25, SOT-89-5, USP-4
				XC6503P****-G	TO-252
4	5	6	7	XC6503B****-G	SOT-25, SOT-89-5, USP-4
8	9	A	B	XC6503C****-G	SOT-25, SOT-89-5, USP-4
C	D	E	F	XC6503D****-G	SOT-25, SOT-89-5, USP-4

③ represents output voltage.

MARK	OUTPUT VOLTAGE (V)				MARK	OUTPUT VOLTAGE (V)			
0	1.20	4.20	1.25	4.25	F	2.70	-	2.75	-
1	1.30	4.30	1.35	4.35	H	2.80	-	2.85	-
2	1.40	4.40	1.45	4.45	K	2.90	-	2.95	-
3	1.50	4.50	1.55	4.55	L	3.00	-	3.05	-
4	1.60	4.60	1.65	4.65	M	3.10	-	3.15	-
5	1.70	4.70	1.75	4.75	N	3.20	-	3.25	-
6	1.80	4.80	1.85	4.85	P	3.30	-	3.35	-
7	1.90	4.90	1.95	4.95	R	3.40	-	3.45	-
8	2.00	5.00	2.05	-	S	3.50	-	3.55	-
9	2.10	-	2.15	-	T	3.60	-	3.65	-
A	2.20	-	2.25	-	U	3.70	-	3.75	-
B	2.30	-	2.35	-	V	3.80	-	3.85	-
C	2.40	-	2.45	-	X	3.90	-	3.95	-
D	2.50	-	2.55	-	Y	4.00	-	4.05	-
E	2.60	-	2.65	-	Z	4.10	-	4.15	-

* USP-4 and TO-252 are under development.

[查询XC6503供应商](#)

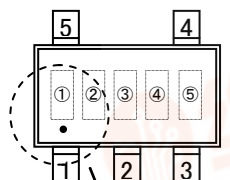
MARKING RULE (Continued)

④⑤ represents production lot number

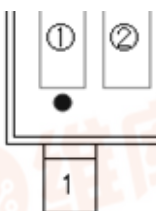
01 to 09, 0A to 0Z, 11 to 9Z, A1 to A9, AA to Z9, ZA to ZZ repeated. (G, I, J, O, Q, W excluded)

* No character inversion used.

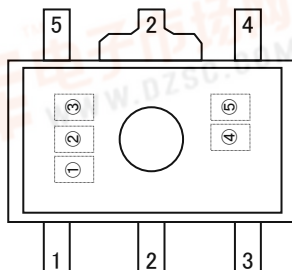
●SOT-25



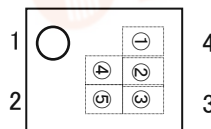
Enlarge



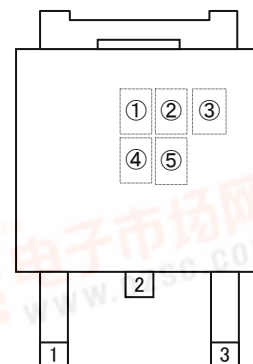
●SOT-89-5



●USP-4



●TO-252



* USP-4 and TO-252 are under development.

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